# **AF Control LSI**

# LC898249AXH

## Overview

This LSI is Closed–Auto Focus control LSI equipped with hall sensor. It consists of 1 system of feedback circuit and constant current driver. It has also a built–in EEPROM and temperature sensor.

## Features

- Built-in Equalizer Circuit Using Digital Operation
  - AF Control Equalizer Circuit
  - Any Coefficient can be Specified by 2-wire Serial I/F (TWIF)
- 2-wire Serial Interface
  - (The Communication Protocol is Compatible with I<sup>2</sup>C)
  - 4 Selectable Slave Addresses
    - 50h(W)/51h(R), 53h(R)
    - 74h(W)/75h(R), 77h(R)
    - E8h(W)/E9h(R), EBh(R)
    - E4h(W)/E5h(R), E7h(R) factory-configured
    - Right Side Addresses are Used at the Access of Built-in EEPROM
- Built-in A/D Converter
- Built-in D/A Converter
  - Hall Offset
  - Constant Current Bias
- Built-in Hall Sensor
  - Si Hall Sensor
- Built-in EEPROM
  - 64 Byte (16 Byte / Page)
- Built-in OSC
- Built-in Constant Current Driver
- ♦ 150 mA
- Package
  - WLCSP 6-pin (2 x 3 Pin), Thickness Max 0.29 mm, with Backside Coat
- Supply Voltage
  - VDD (2.6 V to 3.3 V)
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant



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WLCSP6, 0.86x1.75x0.265 CASE 567XD

## MARKING DIAGRAM

ALYWW
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249AXH = Specific Device Code

- = Assembly Location
- = Wafer Lot
- = Year

A L

Υ

WW = Work Week

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
LC898249AXHTBG	WLCSP6	4,000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **PIN DESCRIPTION**

## Table 1. PIN DESCRIPTION

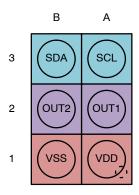
Pin Name	Description
1	Input
Р	Power Supply, GND
NC	Not Connect
0	Output
В	Bidirection

\*Process when pins are not used • 2-wire serial interface PIN TYPE "O" – Ensure that it is set to OPEN. SCL I 2-wire serial interface clock pin PIN TYPE "I" - OPEN is inhibited. Ensure that it is 2-wire serial interface data pin **SDA** В connected to the VDD or VSS even when it is unused. • Driver interface (Please contact ON Semiconductor for more information OUT1 O Driver output (to Actuator) about selection of VDD or VSS.) OUT2 O Driver output (to Actuator) PIN TYPE "B" - If you are unsure about processing method on the pin description of pin layout table, please • Power supply pin contact us. VDD Р Power Supply Note that incorrect processing of unused pins may result in VSS GND Р defects.

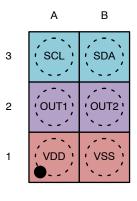
## **PIN LAYOUT**

#### Table 2. PIN LAYOUT

Circuit Name	Number of PINs
Driver	2
Power	2
Logic	2



BOTTOM VIEW

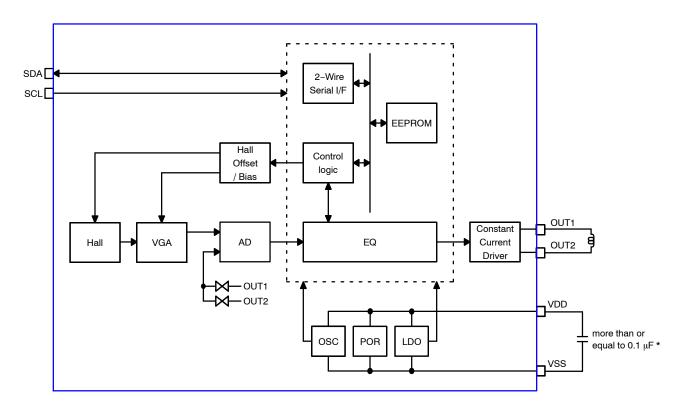


TOP VIEW



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## **BLOCK DIAGRAM**



\*Consider capacitance of capacitor between VDD and VSS. According to power source environment, attach an additional capacitor in camera module.

## Figure 2. Block Diagram

## HALL ELEMENT POSITION

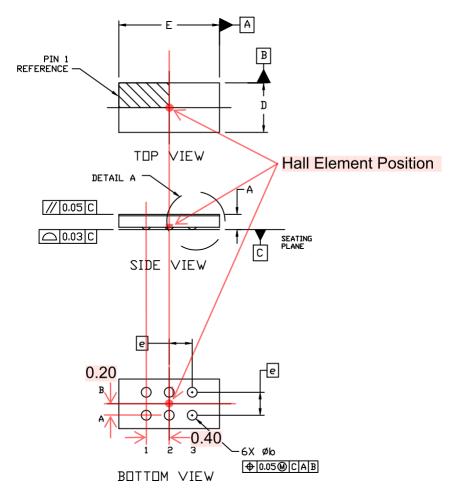


Figure 3. Hall Element Position

## **ELECTRICAL CHARACTERISTICS**

## Table 3. ABSOLUTE MAXIMUM RATINGS (VSS = 0 V)

Symbol	Item	Condition	Rating	Unit
V <sub>DD</sub> 33 max	Supply voltage	Ta ≤ 25°C	-0.3~4.6	V
V <sub>I</sub> 33,V <sub>O</sub> 33	Input/output voltage	Ta≤25°C	-0.3~V <sub>DD</sub> 33 + 0.3	V
Tstg	Storage ambient temperature		-55~125	°C
Topr	Operating ambient temperature		-30~70	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## Table 4. ACCEPTABLE OPERATION RANGE (Ta = -30~70°C, VSS = 0 V, 3 V power supply (VDD))

Symbol	Item	Min	Тур	Max	Unit
V <sub>DD</sub> 33	Supply voltage	2.6	2.8	3.3	V
V <sub>IN</sub>	Input voltage range	0	_	V <sub>DD</sub> 33	V

#### Table 5. DC CHARACTERISTICS (Input / output level at VSS = 0 V, VDD = 2.6 V~3.3V, Ta = -30~70°C)

Symbol	ltem	Condition	Min	Тур	Max	Unit	Applicable Pins
VIH	High-level input voltage	CMOS compliant schmitt	1.4	-	-	V	SCL, SDA
VIL	Low-level input voltage		-	-	0.4	V	
VOL	Low-level output voltage	IOL = 2 mA	-	-	0.2	V	SDA

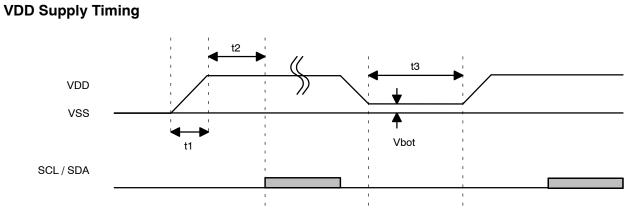
#### Table 6. DRIVER OUTPUT (OUT1, OUT2) (VSS = 0 V, VDD = 2.8 V, Ta = 25°C)

Symbol	ltem	Condition	Min	Тур	Max	Unit	Applicable Pins
lfull	Maximum current		142.5	150	157.5	mA	OUT1, OUT2

#### Table 7. NON-VOLATILE MEMORY CHARACTERISTICS

Symbol	Item	Condition	Min	Тур	Max	Unit	Applicable Circuit
EN	Endurance		-	-	1000	Cycles	EEPROM
RT	Data retention		10	-	-	Years	
tWT	Write time		-	-	20	ms	

## **AC CHARACTERISTICS**



## Figure 4. VDD Supply Timing

It is available to use 2-wire serial interface 5ms later for Power On Reset of VDD.

## Table 8. VDD SUPPLY TIMING

Symbol	Item	Min	Тур	Max	Unit
t1	VDD turn on time	-	-	3	ms
t2	2-wire serial interface start time from VDD on	5	-	-	ms
t3	VDD off time	100	-	-	ms
Vbot	Bottom Voltage	-	-	0.1	V

## **AC Specification**

Figure 5 shows interface timing definition and Table 9 shows electric characteristics.

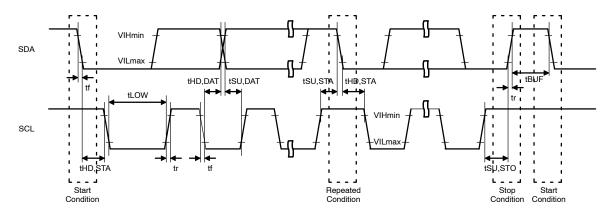


Figure 5. 2-wire Serial Interface Timing Definition

		Pin	F	ast-mod	9	Fas	st-mode P	lus	
Symbol	Item	Name	Min	Тур	Max	Min	Тур	Max	Unit
FSCL	SCL clock frequency	SCL	-	-	400	-	-	1000	kHz
tHD,STA	START condition hold time	SCL SDA	0.6	_	_	0.26	-	-	μs
tLOW	SCL clock Low period	SCL	1.3	-	-	0.5	-	-	μs
tHIGH	SCL clock High period	SCL	0.6	-	-	0.26	-	-	μs
tSU,STA	Setup time for repetition START condition	SCL SDA	0.6	-	_	0.26	-	-	μs
tHD,DAT	Data hold time	SCL SDA	0 (Note 1)	-	0.9	0 (Note 1)	-	-	μs
tSU,DAT	Data setup time	SCL SDA	100	-	-	50	-	-	ns
tr	SDA, SCL rising time	SCL SDA	-	-	300	-	-	120	ns
tf	SDA, SCL falling time	SCL SDA	-	-	300	-	-	120	ns
tSU,STO	STOP condition setup time	SCL SDA	0.6	-	_	0.26	-	-	μs
tBUF	Bus free time between STOP and START	SCL SDA	1.3	_	-	0.5	_	-	μs

## Table 9. ELECTRICAL CHARACTERISTICS FOR 2-WIRE SERIAL INTERFACE (AC CHARACTERISTICS)

1. This LSI is designed for a condition with typ. 20 ns of hold time. If SDA signal is unstable around falling point of SCL signal, please implement an appropriate treatment on board, such as inserting a resistor.

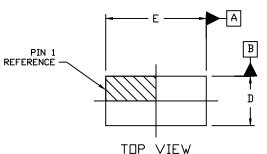
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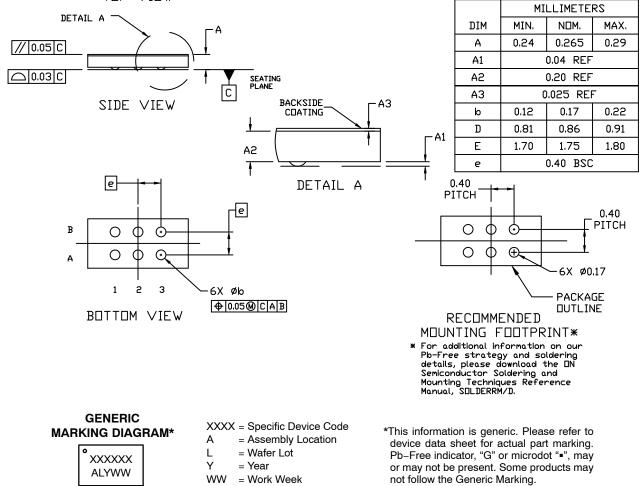
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#### NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPERICAL CROWNS OF THE CONTACT BALLS.
- 4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE CONTACT BALLS.
- 5. DIMENSION 6 IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.



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